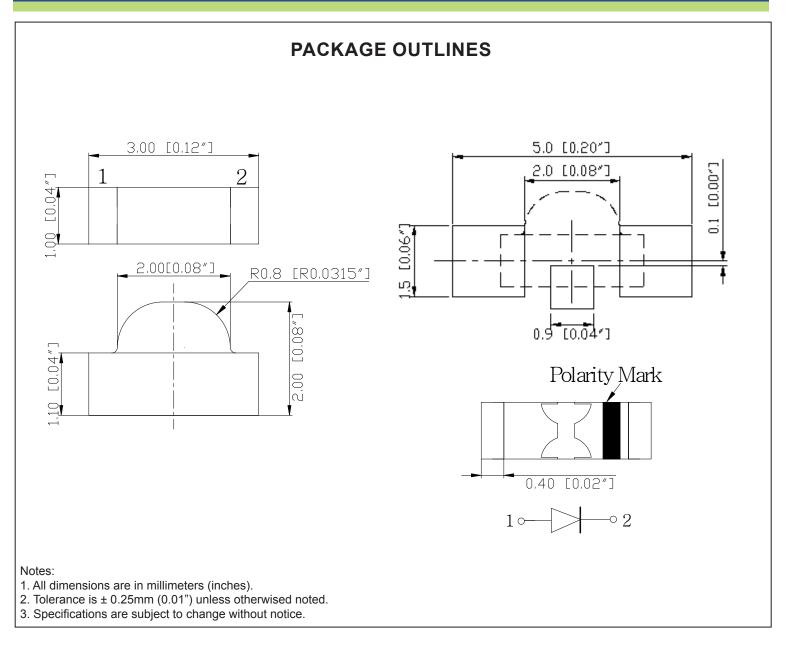


SPECIFICATION





Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle	
CSR123GT2C	InGaN	Green	Water Clear	150°	





ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	30	mA	
Reverse Current @ 5V	lR	10	μA	
Power Dissipation	Pd	111	mW	
Operating Temperature Range	Тор	-40~+80	°C	
Storage Temperature Range	Тѕтс	-40~+85	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lfp	125	mA	
Soldering Temperature	TSOL	Max 260°C for 5 sec Max		

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

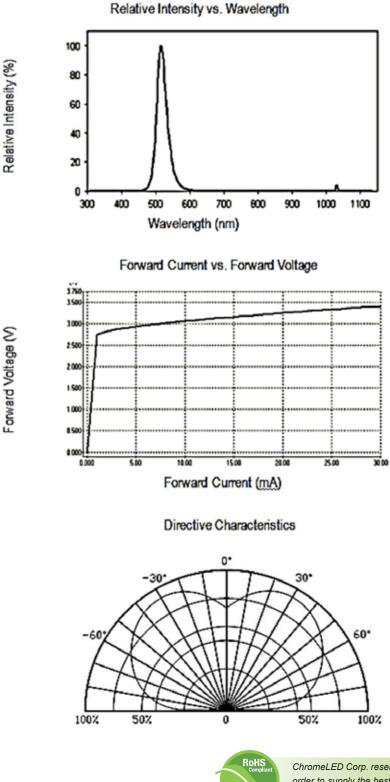
Parameter	Symbol	Test Condition	Value			Unit
			Min	Тур	Max	Unit
Luminous Intensity	Iv	IF = 20mA	200	370	-	mcd
Forward Voltage	Vf	IF = 20mA	-	3.2	3.7	V
Reverse Leakage Current	lr	VR = 5V	-	-	10	μA
Viewing Angle at 50% Iv	201/2	IF = 20mA	-	150	-	Deg
Peak Wavelength	λP	IF = 20mA	-	520	-	nm
Dominant Wavelength	λD	IF = 20mA	-	525	-	nm

*Tolerance of viewing angle: -10 / +5 deg.





OPTICAL CHARACTERISTIC CURVES



ChromeLED Corp. reserves the right to make changes at any time in order to supply the best product possible. The most current version of this document will always be available at: www.chromeled.com

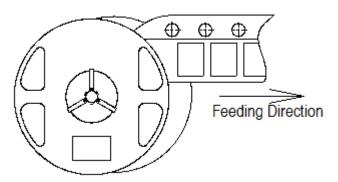
3

Lead Fr

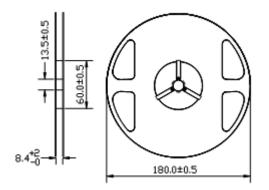


PACKAGING SPECIFICATION

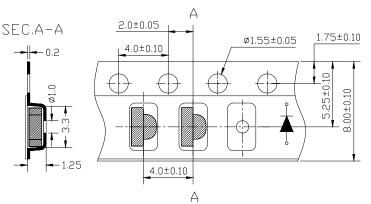
• Feeding Direction



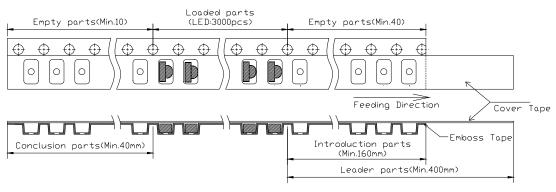
• Dimensions of Reel (unit: mm)



• Dimensions of Tape (unit: mm)



Arrangement of Tape



Notes:

- 1. Empty component pockets are sealed with top cover tape
- 2. Maximum number of missing lamps is two
- 3. Cathode is oriented towards the tape sprocket hole
- 4. 3,000 pcs/Reel

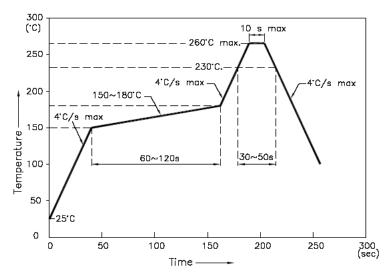




SOLDERING CONDITIONS

REFLOW PROFILE

Reflow Temp/Time



- 1. We Recommend the reflow temperature 245 °C (±5 °C). The maximum soldering temperature should be limited to 260 °C.
- 2. Don't cause stress to epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.
- Soldering Iron

Basic spec is \leq 5 sec when 260 °C. If temperature is higher, time should be shorter (+10 °C \rightarrow -1sec). Power dissipation of iron should be smaller than 20W and temperature should be controllable. Surface temperature of the device should be under 230 °C.

- Rework
 - 1. Customer must finish rework within 5 sec under 260 °C.
 - 2. The head of iron cannot touch copper foil.
 - 3. Twin-head type is preferred.

